DESIGN AND DEVELOPMENT OF MATERIAL CHARACTERIZATION SYSTEM USING MICROWAVE SIGNAL

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DESIGN AND DEVELOPMENT OF MATERIAL CHARACTERIZATION USING MCIROWAVE SIGNAL

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This report is submitted in partial fulfilment of the requirements for the degree of Bachelor of Electronic Engineering with Honours

> Faculty of Electronic and Computer Engineering Universiti Teknikal Malaysia Melaka

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I declare that this report entitled "Design and Development of Material Characterization Using Microwave Signal" is the result of my own work except for quotes as cited in the references.

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APPROVAL

I hereby declare that I have read this thesis and in my opinion this thesis is sufficient in terms of scope and quality for the award of Bachelor of Electronic Engineering with Honours.

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DEDICATION

Specially dedicated to my family:

Mr.Plendran Arjunan

Mr Balan

Mrs Rajeswary

Dr. Poovarasi

Mrs Premavathy

Mr Gobinathan Manickam

Who have encouraged, guided and inspired me throughout of my journey

Mr.Mathialagan Vengadeson

Ms.Narmatha Priya

Dr Sam Weng Yik

& supervisor

PM Dr Zoinol Bin Abdul Aziz

ABSTRACT

Material characterization system is needed to characterize the dielectric properties of the materials. A free space transmission and reflection (T/R) material characterization system is designed to study dielectric properties of wood, FR-4, acrylic, polystyrene and cardboard box. The project started with designing the material characterization system where material placed in between two antennas which are connected to Vector Network Analyzer (VNA) through cables. For characterization purpose, 2x2 microstrip antenna array designed at the resonant frequency 2.4GHz and with gain of 6 dB and 100 MHz of bandwidth. Measurement process carried out in each position of the material and measurement data obtained in reflection coefficient (S11) and transmission coefficient (S21) and analyzed using time-domain analysis. The calculated permittivity of five materials for S11 matches with reference value taken from reliable source. Wood material's calculated permittivity for the distance of 5cm is 2.7 falls within reference range 1.4-2.9 whereas for S21 is 3.8 do not match with it. On other hand, Radar Cross Section (RCS) analysis carried out using MATLAB visually observe the characterization of each material at range of frequencies. It can be concluded, the designed system can characterize material for S11 and S21 successfully for short range of distance only.

ABSTRAK

Sistem pencirian bahan diperlukan untuk mencirikan sifat-sifat dielektrik bahan. Sistem penyaringan bahan ruang bebas ruang dan balikan (T/R) direka untuk mengkaji sifat-sifat dielektrik kayu, FR-4, akrilik, polistirena dan kotak. Projek ini bermula dengan membentuk sistem pencirian material di mana bahan ditempatkan di antara dua antena yang disambungkan ke Vector Network Analyzer (VNA) melalui kabel. Untuk tujuan ini, 2x2 mikrostrip antena array direka pada frekuensi resonan 2.4 GHz dengan gandaan 6 dB serta 100 MHz jalur lebar. Proses pengukuran dilakukan pada setiap kedudukan data bahan dan pengukuran yang diperolehi dalam koefisien pantulan (S11) dan koefisien transmisi (S21) dan dianalisis menggunakan analisis domain waktu. Ketelusan yang dikira untuk lima bahan bagi S11 sama dengan nilai rujukan apabila dibandingkan. Ketelusan yang dikira untuk bahan kayu bagi jarak 5cm ialah 2.7 termasuk dalam julat rujukan 1.4-2.9 manakala bagi S21 adalah 3.8 tidak sepadan dengannya. Selain itu, analisis Radar Cross Section (RCS) yang dijalankan menggunakan MATLAB visual mengamati pencirian setiap bahan pada kekerapan frekuensi. Ia dapat disimpulkan, sistem yang direka bentuk boleh mencirikan bahan untuk S11 dan S21 berjaya untuk jarak pendek sahaja.

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TABLE OF CONTENTS

Declaration	
Approval	
Dedication	
Abstract	1
Abstrak	ii
Acknowledgements	ш
Table of Contents	iv
List of Figures	vii
List of Tables	x
List of Symbols and Abbreviations	xii
List of Appendices	xiii
CHAPTER 1 INTRODUCTION	I
1.1 Project background	1
1.2 Problem Statement	2
1.3 Objective	4
1.4 Scope	4

		v
1.5	Thesis outline	5
СНА	APTER 2 BACKGROUND STUDY	6
2.1	Overview of Available Material Characterization Techniques	6
2.2	Microwave Characterization Techniques	13
2.3	Free-space Characterization Techniques	21
2.4	Microstrip Antenna Array	27
2.5	Summary	31
СНА	APTER 3 METHODOLOGY	32
3.1	Flowchart of the Project	33
3.2	Microwave Characterization System	35
3.3	Hardware Development	39
	3.3.1 2x2 Microstrip Antenna Array Design	41
	3.3.1.1 2x2 Microstrip Antenna Array Design Process	42
	3.3.1.2 Simulation Process	49
	3.3.1.3 Fabrication Process	50
	3.3.1.4 Measurement Process of 2x2 Microstrip Antenna Array	52
3.4	Software development	55
	3.4.1 MATLAB Coding for Time-Domain Analysis	55
	3.4.2 MATLAB Coding for Radar Cross Section (RCS)	56
3.5	Material Characterization Measurement Process	56

		vī
3.6	Summary	59
CHA	APTER 4 RESULTS AND DISCUSSION	60
4.1	2x2 Microstrip Array Antenna's Simulation Results	60
4.2	Material Characterization Result Analysis	65
4.3	Time-domain Analysis of Five Materials	66
	4.3.1 Time-Domain Analysis of Wood	68
	4.3.2 Time-domain Analysis of FR-4	75
	4.3.3 Time-domain Analysis of Acrylic	79
	4.3.4 Time-domain Analysis of Polystyrene	83
	4.3.5 Time-domain Analysis of Cardboard box	86
4.4	Accuracy Level of Designed Characterization System	89
4.5	Radar Cross Sectioning (RCS)	90
4.6	Summary	98
CHA	APTER 5 CONCLUSION AND FUTURE WORKS	99
5.1	Conclusion	99
5.2	Future Recommendations	100
REF	TERENCES	101
APP	ENDICES	107

LIST OF FIGURES

Figure 2.1: Schematic diagram of ion chromatography detection	9
Figure 2.2: Principle of the insertion-substitution method	9
Figure 2.3: Laser ultrasonic testing system	10
Figure 2.4: Typical XRF system	11
Figure 2.5: Free space transmission setup	12
Figure 2.6: Block diagram of reflectometer	12
Figure 2.7: Open-ended coaxial probe experiment	15
Figure 2.8: Parallel-plate series element	16
Figure 2.9: Microstrip transmission line experiment setup	16
Figure 2.10: Textile antenna	18
Figure 2.11: Free space transmission and reflection setup	18
Figure 2.12: Free space measurement setup	19
Figure 2.13: Free space setup for low-loss samples	20
Figure 2.14: The experimental setup in reflection configuration	22
Figure 2.15: Block diagram of W-band ellipsometer	23
Figure 2.16: Block schematic of the measurement setup	24
Figure 2.17: Measurement system for low loss dielectric slab	24
Figure 2.18: Free space time domain measurement setup	25

Figure 2.19: Monitoring fruit classification measurement setup	26	
Figure 2.20: 2X2 L-slot Antenna Array	28	
Figure 2.21: Phased Array Antenna	28	
Figure 2.22: 2x2x and 2x4 circular patch antenna array	29	
Figure 2.23: Rectangular Patch Antenna Array	29	
Figure 2.24: Multi-layer patch antenna array	30	
Figure 3.1: Flowchart of project	33	
Figure 3.2: Block diagram of measurement setup	35	
Figure 3.3: Flowchart of time-domain analysis	38	
Figure 3.4: Flowchart of RCS	39	
Figure 3.5: Flowchart of designing 2x2 microstrip antenna array	41	
Figure 3.6: Geometry of microstrip patch antenna	42	
Figure 3.7: Microstrip single rectangular patch antenna	44	
Figure 3.8: 2x1 microstrip antenna array	45	
Figure 3.9: 2x2 microstrip antenna array	45	
Figure 3.10: Design Process Flow Chart	45	
Figure 3.11: Fabrication 2x2 microstrip antenna array	51	
Figure 3.12: Flow chart of fabrication process	52	
Figure 3.13: Measurement setup for (a) Return Loss (b) Gain (c) Far-field	54	
Figure 3.14: Material characterization process for time-domain analysis	57	
Figure 3.15: Material characterization process for RCS analysis	57	
Figure 3.16: Dimension of the antenna	58	
Figure 3.17: Measurement process for RCS	59	
	 Figure 2.19: Monitoring fruit classification measurement setup Figure 2.20: 2X2 L-slot Antenna Array Figure 2.21: Phased Array Antenna Figure 2.22: 2x2x and 2x4 circular patch antenna array Figure 2.23: Rectangular Patch Antenna Array Figure 2.24: Multi-layer patch antenna array Figure 3.1: Flowchart of project Figure 3.2: Block diagram of measurement setup Figure 3.3: Flowchart of time-domain analysis Figure 3.4: Flowchart of RCS Figure 3.6: Geometry of microstrip patch antenna Figure 3.7: Microstrip single rectangular patch antenna Figure 3.8: 2x1 microstrip antenna array Figure 3.9: 2x2 microstrip antenna array Figure 3.10: Design Process Flow Chart Figure 3.12: Flow chart of fabrication process Figure 3.13: Measurement setup for (a) Return Loss (b) Gain (c) Far-field Figure 3.14: Material characterization process for RCS analysis Figure 3.16: Dimension of the antenna Figure 3.17: Measurement process for RCS 	Figure 2.19: Monitoring fruit classification measurement setup26Figure 2.20: 2X2 L-slot Antenna Array28Figure 2.21: Phased Array Antenna28Figure 2.22: 2x2x and 2x4 circular patch antenna array29Figure 2.23: Rectangular Patch Antenna Array29Figure 2.24: Multi-layer patch antenna array30Figure 3.1: Flowchart of project33Figure 3.2: Block diagram of measurement setup35Figure 3.3: Flowchart of time-domain analysis38Figure 3.4: Flowchart of RCS39Figure 3.5: Flowchart of designing 2x2 microstrip antenna array41Figure 3.6: Geometry of microstrip patch antenna42Figure 3.7: Microstrip single rectangular patch antenna45Figure 3.9: 2x2 microstrip antenna array45Figure 3.11: Fabrication 2x2 microstrip antenna array51Figure 3.12: Flow chart of fabrication process52Figure 3.13: Measurement setup for (a) Return Loss (b) Gain (c) Far-field54Figure 3.15: Material characterization process for RCS analysis57Figure 3.16: Dimension of the antenna58Figure 3.17: Measurement process for RCS59

viii

Figure 4.1: Comparison of return loss	61
Figure 4.2: (a) Measured and simulated return loss of Antenna 1	61
Figure 4.3: (b) Measured and simulated return loss of Antenna 2	61
Figure 4.3: (c) Measured and simulated return loss of Antenna 1 and	d 2 61
Figure 4.3: (a) Gain for single patch antenna	63
Figure 4.3: (b) Gain for 2x1 antenna array	62
Figure 4.3: (c) Gain for 2x2 antenna array	63
Figure 4.4: Radiation pattern of 2x2 antenna array	65
Figure 4.5: Time-domain analysis for without material	68
Figure 4.6: (a) Time-domain analysis of wood at distance of 5cm (S	68
Figure 4.6: (b) Time-domain analysis of wood at distance of 5cm (S	69
Figure 4.7: (a) Magnitude difference of wood for S11 at 5cm	70
Figure 4.7: (b) Magnitude difference of wood for S21 at 5cm	70
Figure 4.8: (a) Magnitude difference of wood (S11)	71
Figure 4.8: (b) Magnitude difference of wood (S21)	71
Figure 4.9: (a) Magnitude difference of FR-4 for all distances (S11)	75
Figure 4.9: (b) Magnitude difference of FR-4 for all distances (S21)	76
Figure 4.10: (a) Magnitude difference of acrylic for all distances (S1	1) 79
Figure 4.10: (b) Magnitude difference of acrylic for all distances (S2	21) 80
Figure 4.11: (a) Magnitude difference of polystyrene for all distance	es (S11) 83
Figure 4.11: (b) Magnitude difference of polystyrene for all distance	es (S21) 84
Figure 4.12: (a) Magnitude difference of box for all distances (S11)	86
Figure 4.12: (b) Magnitude difference of box for all distances (S21)	87

ix

LIST OF TABLES

Table 2.1: Types of characterization techniques in various field	8
Table 2.2: Microwave characterization techniques	15
Table 2.3: Free-space material characterization techniques	22
Table 2.4: Types of microstrip antenna array	28
Table 3.1: Specifications required to design the characterization system	36
Table 3.2: 2x2 microstrip antenna array design specifications	43
Table 3.3: Specification of material	43
Table 3.4: 2x2 antenna design process	44
Table 3.5: Antenna Design Parameters	48
Table 3.6: The coaxial probe feeding dimensions in simulation	50
Table 4.1: Overall simulation results	64
Table 4.2: Comparison between simulation and measurement for both arrays	65
Table 4.3: Calculated permittivity of wood for all the distances (S11)	72
Table 4.4: Calculated permittivity of wood for all the distances (S21)	73
Table 4.5: Comparison between calculated and reference permittivity (wood)	74
Table 4.6: Calculated permittivity of FR-4 for all the distances (S11)	76
Table 4.7: Calculated permittivity of FR-4 for all the distances (S21)	78
Table 4.8: Comparison between calculated and reference permittivity (FR-4)	78

Table 4.9: Calculated permittivity of acrylic for all the distance (S11)	80	
Table 4.10: Calculated permittivity of acrylic for all distance (S21)	81	
Table 4.11: Comparison between calculated and reference permittivity (acrylic)	82	
Table 4.12: Calculated permittivity of polystyrene for all distance (S11)	84	
Table 4.13: Calculated permittivity of polystyrene for all distance (S21)	85	
Table 4.14: Comparison between calculated and reference permittivity		
(polystyrene)	86	
Table 4.15: Calculated permittivity of cardboard box for all distance (S11)	87	
Table 4.16: Calculated permittivity of cardboard box for all distance (S21)	88	
Table 4.17: Comparison between calculated and reference permittivity (box)	89	
Table 4.18: Overall percentage error of the system for each material	90	
Table 4.19: Radar Cross Sectioning of reflection coefficient, S11	92	
Table 4.20: Radar Cross Sectioning of transmission coefficient, S21	95	

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xī

LIST OF SYMBOLS AND ABBREVIATIONS

AUT	2	Antenna Under Test
MUT	2	Material Under Test
S11	:	Reflection Coefficient
S21	4	Transmission Coefficient
VNA	4	Vector Network Analyzer
XRF	đ	X-ray Fluorescence
d	÷	Distance
RCS	÷	Radar Cross Section

LIST OF APPENDICES

Appendix A: Code for Time-domain Analysis

107

CHAPTER 1

INTRODUCTION

This chapter briefly discuss on the project background. This chapter also includes problem statement, objective, scope of the project and the thesis outline

1.1 Project background

Material characterization is very essential nowadays since it is mainly focused in numerous applications ranging from designing electronic circuit to satellite applications. Material characterization is mainly about characterizing a material's properties in terms of chemical, mechanical and physical. As for instance, physical characteristic of material incorporate color, dimension, texture and thickness that defines the material physically. Properties that describes how a substance changes into completely different substance are called chemical properties such as flammability, oxidation or corrosion resistance. On other hand, mechanical properties of material are those properties that involve a reaction to an applied load. The most common mechanical properties are stiffness, ductility, impact resistance and fracture toughness.

The need of material characterization is for determining a particular material's properties to enhance its functionality or properties and also classify them in applications it belongs to. Without characterizing material properly, classifying cannot be performed accurately and this may leads to damage to the material and to the user of the material. Thus, material characterization is important and there are numerous techniques presented such as chemical analysis, ultrasonic characterization, x-ray spectrometry characterization and microwave characterization.

Our main focus of this project is characterization involving free space measurements of solid materials. When it comes to characterizing material in microwave frequency region, the main attention is given to dielectric properties of material. Dielectric properties plays important role in a material because it is providing beneficial details about the storage and dissipation of electric and magnetic in materials and also provides insight into the feasibility of using the material in potential applications.

1.2 Problem Statement

Material characterization is the process of measuring and determining physical, chemical, mechanical and microstructural properties of materials. Through characterization process, able to extract fundamental properties of any type material. It also determines the use of material along with its advantages and deficiency. Adding to that, characterization of materials helps to understand and quantify whether a specific material is suitable to a particular application. Thus, if at all the materials are not properly characterized and used in an automotive, aerospace or biomedical product can be very dangerous as it has the potential of putting user in danger.

In general, materials can be classified into conductors, semiconductors and insulators or dielectric materials. Hence, dielectric materials plays an important role in our daily life especially every electronic circuit. In most cases, electronic circuits are built using dielectric materials for high frequency operations and performance of the operation is totally depends on the dielectric properties of the material that used to build in. Consequently, there is need to have understanding of the properties of dielectric materials at such operating frequency.

The measurement of dielectric properties at microwave frequency as well as in radio frequency (RF) is very relevant especially in the analysis exploration, such as in biomaterial science, telecommunication field and also microwave circuit design. Ordinarily, the techniques used for the microwave characterization of dielectric materials are classified into different groups which are transmission/ reflection line method, open ended coaxial method, component design approach and free space method.

Most of these techniques are widely used and each techniques has its own constraints along with the frequency at which the measurements can be performed and the type of material that can be measured. Component design approach and free space measurement technique is our main focus in microwave characterization.

Component design approach is concerned to materials for designing such as antennas, absorber and sensor to enhance the performance in its own application. When it comes to component design approach, the process of characterizing the materials takes a longer time. This is mainly because the material has to be characterized under different technical design parameters. Thus, it also cause a delay in simulation process.

Moreover, component design approach is not universal in where it is not applicable other than its own application because it may not function accurately due to the difference in structure and properties of material. Adding to that, component design approach is considered as the destructive technique that can damage the material. This is because due to characterizing the same material under different technical parameters repetitively.

The drawbacks of component design approach can be overcome with free space transmission-reflection method known as non-destructive technique. In transmissionreflection method, object is the interface between transmitter and receiver. A simple setup is only needed that do not requires expensive equipment for characterizing purpose. Since, this method can be considered more pragmatic approach, we have considered to apply this technique to characterize the dielectric properties of solids.

1.3 Objective

 Design and develop material characterization system based on free space transmission-reflection method to characterize dielectric properties of solids.

1.4 Scope

The scope of project are listed as below:

 Design and develop a free space transmission-reflection (T/R) measurement system to characterize dielectric properties of solids.

4

- System integration deployment of free space transmission-reflection (T/R) measurement system.
- Testing the developed free space transmission-reflection (T/R) measurement system to characterize dielectric properties of solids

1.5 Thesis outline

This thesis consists of five chapters which are categorized as below:

Chapter 1: Introduction-This chapter introduces and explains the purpose of this project through problem statement, objective and scope of the project.

Chapter 2: Literature Survey- This chapter provides a detailed background of the material characterization and methods used to characterize material properties.

Chapter 3: Methodology- This chapter describes the methods and procedures used to design this project in details as well as flow charts, discussion on selection of method to be used in this project and further details to design the system.

Chapter 4: Result and discussion- This chapter illustrates and analyses the result of this project and discusses the possible further improvements of the developed device.

Chapter 5: Conclusion and recommendation- This chapter presents the conclusion of the project. The strengths and limitation of the project will be highlighted as well. Furthermore, some recommendations for future works will be provided.